



74HC112; 74HCT112

Dual JK flip-flop with set and reset; negative-edge trigger

Rev. 5 — 15 January 2024

Product data sheet

1. General description

The 74HC112; 74HCT112 is a dual negative-edge triggered JK flip-flop. It features individual J and K inputs, clock ($\overline{nCP}$) set ($\overline{nSD}$) and reset ($\overline{nRD}$) inputs. It also has complementary nQ and $n\overline{Q}$ outputs. The set and reset are asynchronous active LOW inputs and operate independently of the clock input. The J and K inputs control the state changes of the flip-flops as described in the mode select function table. The J and K inputs must be stable one set-up time prior to the HIGH-to-LOW clock transition for predictable operation. Inputs include clamp diodes that enable the use of current limiting resistors to interface inputs to voltages in excess of V_{CC} .

Schmitt-trigger action in the clock input makes the circuit highly tolerant to slower clock rise and fall times.

2. Features and benefits

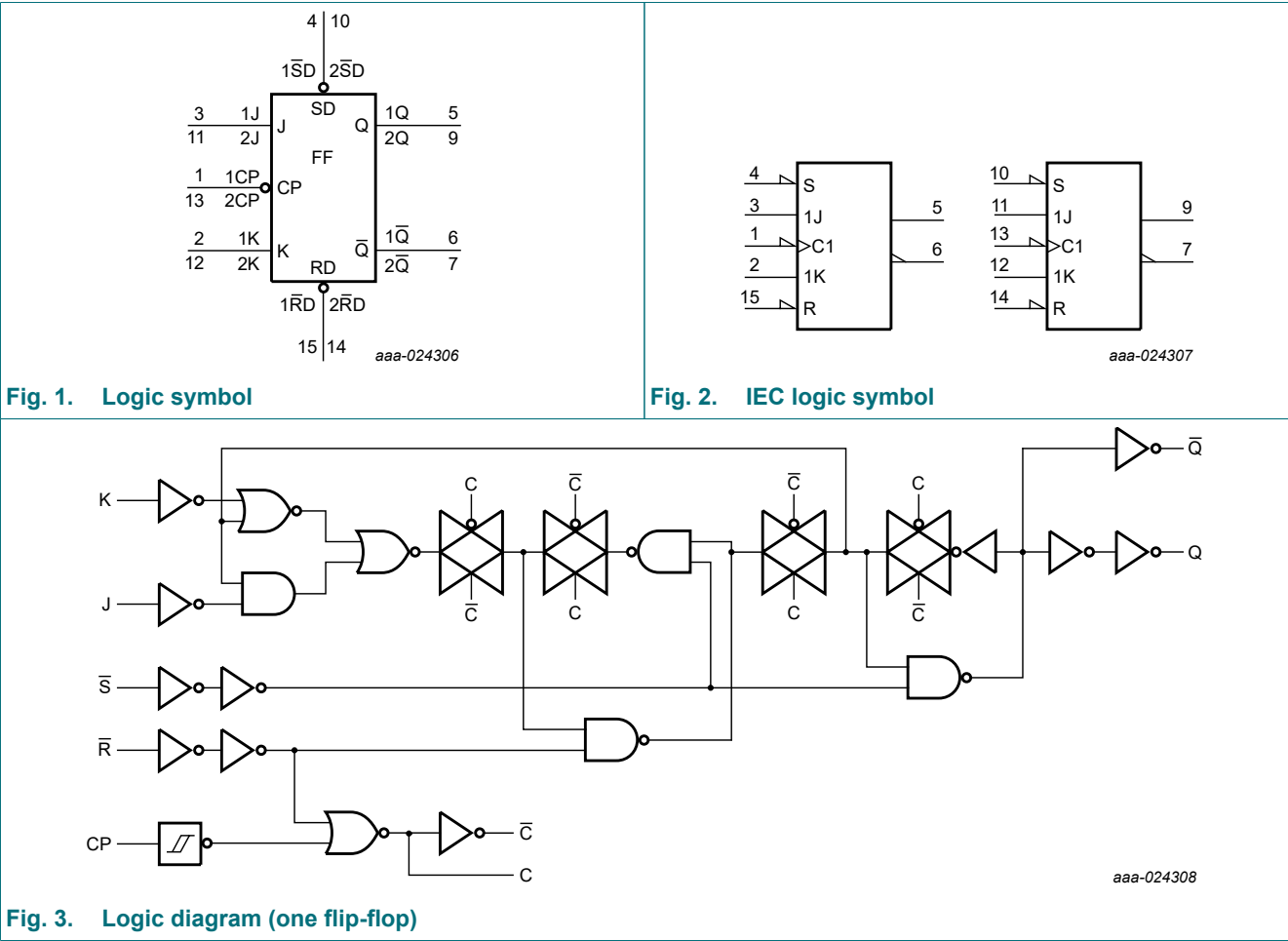
- Input levels:
 - For 74HC112: CMOS level
 - For 74HCT112: TTL level
- Asynchronous set and reset
- Specified in compliance with JEDEC standard no. 7A
- ESD protection:
 - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
 - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

3. Ordering information

Table 1. Ordering information

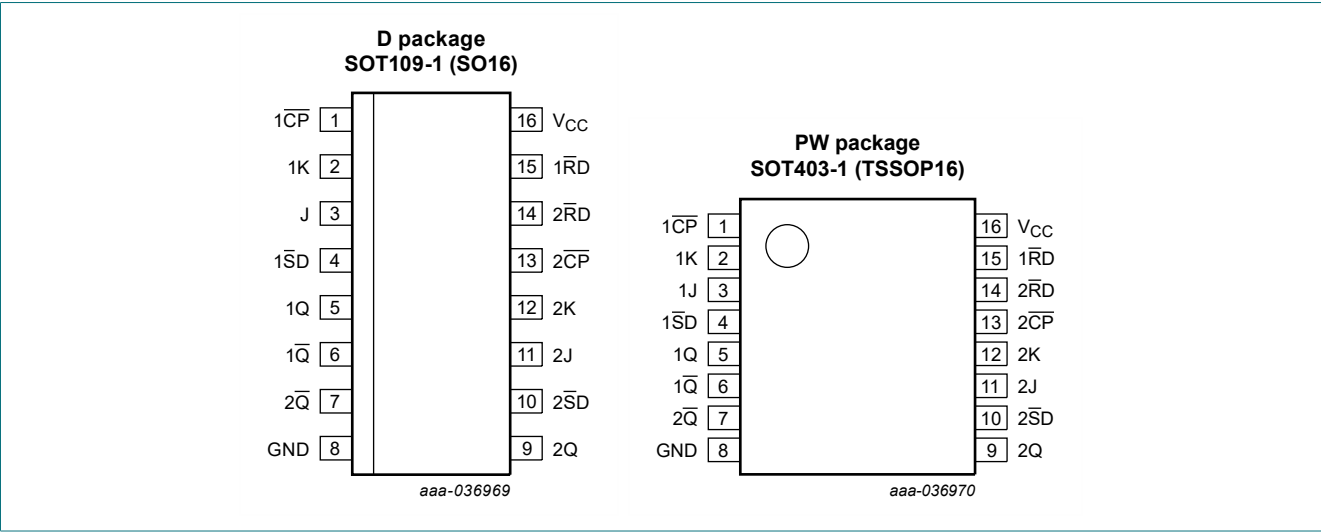
Type number	Package			
	Temperature range	Name	Description	Version
74HC112D 74HCT112D	-40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1
74HC112PW 74HCT112PW	-40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1

4. Functional diagram



5. Pinning information

5.1. Pinning



5.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
1CP, 2CP	1, 13	clock input (HIGH-to-LOW; edge-triggered)
1K, 2K	2, 12	data input
1J, 2J	3, 11	data input
1SD, 2SD	4, 10	set input (active LOW)
1Q, 2Q	5, 9	true flip-flop output
1Q, 2Q	6, 7	complement flip-flop output
GND	8	ground (0 V)
1RD, 2RD	15, 14	reset input (active LOW)
VCC	16	supply voltage

6. Functional description

Table 3. Function selection

If nSD and nRD simultaneously go from LOW-to-HIGH, the output states are unpredictable.
H = HIGH voltage level; h = HIGH voltage level one set-up time before the HIGH-to-LOW clock transition;
L = LOW voltage level; l = LOW voltage level one set-up time before the HIGH-to-LOW clock transition;
q = lowercase letters indicate the state of the referenced output one set-up time before the HIGH-to-LOW clock transition;
X = don't care; ↓ = HIGH-to-LOW clock transition.

Operating modes	Input					Output	
	nSD	nRD	nCP	nJ	nK	nQ	nQ
Asynchronous set	L	H	X	X	X	H	L
Asynchronous reset	H	L	X	X	X	L	H
Undetermined	L	L	X	X	X	H	L
Toggle	H	H	↓	h	h	q	q
Load 0 (reset)	H	H	↓	l	h	L	H
Load 1 (set)	H	H	↓	h	l	H	L
Hold no change	H	H	↓	l	l	q	q

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+7	V
I _{IK}	input clamping current	V _I < -0.5 V or V _I > V _{CC} + 0.5 V	-	±20	mA
I _{OK}	output clamping current	V _O < -0.5 V or V _O > V _{CC} + 0.5 V	-	±20	mA
I _O	output current	-0.5 V < V _O < V _{CC} + 0.5 V	-	±25	mA
I _{CC}	supply current		-	+50	mA
I _{GND}	ground current		-50	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	[1]	-	500	mW

[1] For SOT109-1 (SO16) package: P_{tot} derates linearly with 12.4 mW/K above 110 °C.
For SOT403-1 (TSSOP16) package: P_{tot} derates linearly with 8.5 mW/K above 91 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	74HC112			74HCT112			Unit
			Min	Typ	Max	Min	Typ	Max	
V _{CC}	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
V _I	input voltage		0	-	V _{CC}	0	-	V _{CC}	V
V _O	output voltage		0	-	V _{CC}	0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C
Δt/ΔV	input transition rise and fall rate	V _{CC} = 2.0 V	-	-	625	-	-	-	ns/V
		V _{CC} = 4.5 V	-	1.67	139	-	1.67	139	ns/V
		V _{CC} = 6.0 V	-	-	83	-	-	-	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
74HC112										
V _{IH}	HIGH-level input voltage	V _{CC} = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
		V _{CC} = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V _{CC} = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
		V _{CC} = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V _{CC} = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V

Dual JK flip-flop with set and reset; negative-edge trigger

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
V _{OH}	HIGH-level output voltage	V _I = V _{IH} or V _{IL}								
		I _O = -20 µA; V _{CC} = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		I _O = -20 µA; V _{CC} = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -20 µA; V _{CC} = 6.0 V	5.9	6.0	-	5.9	-	5.9	-	V
		I _O = -4.0 mA; V _{CC} = 4.5 V	3.98	4.32	-	3.84	-	3.7	-	V
		I _O = -5.2 mA; V _{CC} = 6.0 V	5.48	5.81	-	5.34	-	5.2	-	V
V _{OL}	LOW-level output voltage	V _I = V _{IH} or V _{IL}								
		I _O = 20 µA; V _{CC} = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 20 µA; V _{CC} = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 20 µA; V _{CC} = 6.0 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 4.0 mA; V _{CC} = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		I _O = 5.2 mA; V _{CC} = 6.0 V	-	0.16	0.26	-	0.33	-	0.4	V
I _I	input leakage current	V _I = V _{CC} or GND; V _{CC} = 6.0 V	-	-	±0.1	-	±1	-	±1	µA
I _{CC}	supply current	V _I = V _{CC} or GND; I _O = 0 A; V _{CC} = 6.0 V	-	-	4.0	-	40	-	80	µA
C _I	input capacitance		-	3.5	-	-	-	-	-	pF
74HCT112										
V _{IH}	HIGH-level input voltage	V _{CC} = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
V _{IL}	LOW-level input voltage	V _{CC} = 4.5 V to 5.5 V	-	1.2	0.8	-	0.8	-	0.8	V
V _{OH}	HIGH-level output voltage	V _I = V _{IH} or V _{IL} ; V _{CC} = 4.5 V								
		I _O = -20 µA	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -4.0 mA	3.98	4.32	-	3.84	-	3.7	-	V
V _{OL}	LOW-level output voltage	V _I = V _{IH} or V _{IL} ; V _{CC} = 4.5 V								
		I _O = 20 µA; V _{CC} = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 4.0 mA; V _{CC} = 5.5 V	-	0.15	0.26	-	0.33	-	0.4	V
I _I	input leakage current	V _I = V _{CC} or GND; V _{CC} = 5.5 V	-	-	±0.1	-	±1	-	±1	µA
I _{CC}	supply current	V _I = V _{CC} or GND; I _O = 0 A; V _{CC} = 5.5 V	-	-	4.0	-	40	-	80	µA
ΔI _{CC}	additional supply current	per input pin; V _I = V _{CC} - 2.1 V; other inputs at V _{CC} or GND; V _{CC} = 4.5 V to 5.5 V								
		n $\overline{\text{SD}}$ inputs	-	50	180	-	225	-	245	µA
		nK inputs	-	60	216	-	270	-	294	µA
		n $\overline{\text{RD}}$ inputs	-	65	236	-	293	-	319	µA
		nJ, and n $\overline{\text{CP}}$ inputs	-	100	360	-	450	-	490	µA
C _I	input capacitance		-	3.5	-	-	-	-	-	pF

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); C_L = 50 pF unless otherwise specified; for test circuit, see Fig. 6.

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	Min	Max	
74HC112										
t _{pd}	propagation delay	nCP to nQ; see Fig. 4 [2]								
		V _{CC} = 2.0 V	-	55	175	-	220	-	265	ns
		V _{CC} = 4.5 V	-	20	35	-	44	-	53	ns
		V _{CC} = 5 V; C _L = 15 pF	-	17	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	16	30	-	37	-	45	ns
		nCP to nQ̄; see Fig. 4								
		V _{CC} = 2.0 V	-	55	175	-	220	-	265	ns
		V _{CC} = 4.5 V	-	20	35	-	44	-	53	ns
		V _{CC} = 5 V; C _L = 15 pF	-	17	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	16	30	-	37	-	45	ns
		nRD to nQ, nQ̄; see Fig. 5								
		V _{CC} = 2.0 V	-	58	180	-	225	-	270	ns
		V _{CC} = 4.5 V	-	21	36	-	45	-	54	ns
		V _{CC} = 5 V; C _L = 15 pF	-	18	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	17	31	-	38	-	46	ns
		nSD to nQ, nQ̄; see Fig. 5								
		V _{CC} = 2.0 V	-	50	155	-	295	-	235	ns
		V _{CC} = 4.5 V	-	18	31	-	39	-	47	ns
		V _{CC} = 5 V; C _L = 15 pF	-	15	-	-	-	-	-	ns
		V _{CC} = 6.0 V	-	14	26	-	33	-	40	ns
t _t	transition time	nQ, nQ̄; see Fig. 4 [3]								
		V _{CC} = 2.0 V	-	19	75	-	95	-	110	ns
		V _{CC} = 4.5 V	-	7	15	-	19	-	22	ns
		V _{CC} = 6.0 V	-	6	13	-	16	-	19	ns
t _w	pulse width	nCP HIGH or LOW; see Fig. 4								
		V _{CC} = 2.0 V	80	22	-	100	-	120	-	ns
		V _{CC} = 4.5 V	16	8	-	20	-	24	-	ns
		V _{CC} = 6.0 V	14	6	-	17	-	20	-	ns
		nSD, nRD LOW; see Fig. 5								
		V _{CC} = 2.0 V	80	22	-	100	-	120	-	ns
		V _{CC} = 4.5 V	16	8	-	20	-	24	-	ns
V _{CC} = 6.0 V	14	6	-	17	-	20	-	ns		

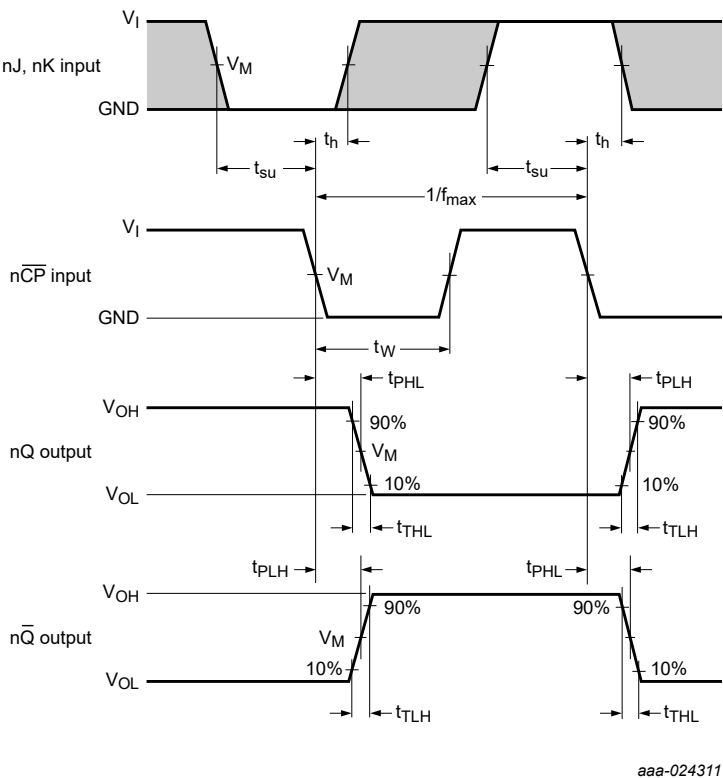
Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	Min	Max	
t_{rec}	recovery time	nRD to nCP ; see Fig. 5								
		$V_{\text{CC}} = 2.0 \text{ V}$	80	22	-	125	-	150	-	ns
		$V_{\text{CC}} = 4.5 \text{ V}$	16	8	-	25	-	30	-	ns
		$V_{\text{CC}} = 6.0 \text{ V}$	14	6	-	21	-	26	-	ns
		nSD to nCP ; see Fig. 5								
		$V_{\text{CC}} = 2.0 \text{ V}$	80	-19	-	100	-	120	-	ns
		$V_{\text{CC}} = 4.5 \text{ V}$	16	-7	-	20	-	24	-	ns
		$V_{\text{CC}} = 6.0 \text{ V}$	14	-6	-	17	-	20	-	ns
t_{su}	set-up time	nJ and nK to nCP ; see Fig. 4								
		$V_{\text{CC}} = 2.0 \text{ V}$	80	19	-	100	-	120	-	ns
		$V_{\text{CC}} = 4.5 \text{ V}$	16	7	-	20	-	24	-	ns
		$V_{\text{CC}} = 6.0 \text{ V}$	14	6	-	17	-	20	-	ns
t_{h}	hold time	nJ and nK to nCP ; see Fig. 4								
		$V_{\text{CC}} = 2.0 \text{ V}$	0	-11	-	0	-	0	-	ns
		$V_{\text{CC}} = 4.5 \text{ V}$	0	-4	-	0	-	0	-	ns
		$V_{\text{CC}} = 6.0 \text{ V}$	0	-3	-	0	-	0	-	ns
f_{max}	maximum frequency	nCP ; see Fig. 4								
		$V_{\text{CC}} = 2.0 \text{ V}$	6	20	-	4.8	-	4.0	-	MHz
		$V_{\text{CC}} = 4.5 \text{ V}$	30	60	-	24	-	20	-	MHz
		$V_{\text{CC}} = 5 \text{ V}; C_{\text{L}} = 15 \text{ pF}$	-	66	-	-	-	-	-	MHz
		$V_{\text{CC}} = 6.0 \text{ V}$	35	71	-	28	-	24	-	MHz
C_{PD}	power dissipation capacitance	$C_{\text{L}} = 50 \text{ pF}; f = 1 \text{ MHz}; V_{\text{I}} = \text{GND to } V_{\text{CC}}$ [4]	-	27	-			-	-	pF
74HCT112										
t_{pd}	propagation delay	nCP to nQ ; see Fig. 4 [2]								
		$V_{\text{CC}} = 4.5 \text{ V}$	-	21	35	-	44	-	53	ns
		$V_{\text{CC}} = 5 \text{ V}; C_{\text{L}} = 15 \text{ pF}$	-	19	-	-	-	-	-	ns
		nCP to nQ ; see Fig. 4								
		$V_{\text{CC}} = 4.5 \text{ V}$	-	23	40	-	50	-	60	ns
		$V_{\text{CC}} = 5 \text{ V}; C_{\text{L}} = 15 \text{ pF}$	-	19	-	-	-	-	-	ns
		nRD to nQ, nQ ; see Fig. 5								
		$V_{\text{CC}} = 4.5 \text{ V}$	-	22	37	-	46	-	56	ns
		$V_{\text{CC}} = 5 \text{ V}; C_{\text{L}} = 15 \text{ pF}$	-	19	-	-	-	-	-	ns
		nSD to nQ, nQ ; see Fig. 5								
		$V_{\text{CC}} = 4.5 \text{ V}$	-	18	32	-	40	-	48	ns
		$V_{\text{CC}} = 5 \text{ V}; C_{\text{L}} = 15 \text{ pF}$	-	15	-	-	-	-	-	ns
t_{t}	transition time	nQ, nQ ; see Fig. 4 [3]								
		$V_{\text{CC}} = 4.5 \text{ V}$	-	7	15	-	19	-	22	ns
t_{W}	pulse width	nCP HIGH or LOW; see Fig. 4								
		$V_{\text{CC}} = 4.5 \text{ V}$	16	8	-	20	-	24	-	ns
		nSD, nRD LOW; see Fig. 5								
		$V_{\text{CC}} = 4.5 \text{ V}$	18	10	-	23	-	27	-	ns

Dual JK flip-flop with set and reset; negative-edge trigger

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ[1]	Max	Min	Max	Min	Max	
t _{rec}	recovery time	nRD to nCP; see Fig. 5								
		V _{CC} = 4.5 V	20	11	-	25	-	30	-	ns
		nSD to nCP; see Fig. 5								
		V _{CC} = 4.5 V	20	-8	-	25	-	30	-	ns
t _{su}	set-up time	nJ and nK to nCP ; see Fig. 4								
		V _{CC} = 4.5 V	16	7	-	20	-	24	-	ns
t _h	hold time	nJ and nK to nCP; see Fig. 4								
		V _{CC} = 4.5 V	0	-7	-	0	-	0	-	ns
f _{max}	maximum frequency	nCP; see Fig. 4								
		V _{CC} = 4.5 V	30	64	-	24	-	20	-	MHz
		V _{CC} = 5 V; C _L = 15 pF	-	70	-	-	-	-	-	MHz
C _{PD}	power dissipation capacitance	C _L = 50 pF; f = 1 MHz; V _I = GND to V _{CC} [4]	-	30	-	-	-	-	-	pF

[1] All typical values are measured at T_{amb} = 25 °C.
[2] t_{pd} is the same as t_{PLH} and t_{PHL}.
[3] t_i is the same as t_{THL} and t_{TLH}.
[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).
P_D = C_{PD} × V_{CC}² × f_i × N + Σ(C_L × V_{CC}² × f_o) where:
f_i = input frequency in MHz;
f_o = output frequency in MHz;
C_L = output load capacitance in pF;
V_{CC} = supply voltage in V;
N = number of inputs switching;
Σ(C_L × V_{CC}² × f_o) = sum of outputs.

10.1. Waveforms and test circuit



Measurement points are given in [Table 8](#).
 V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig. 4. Clock propagation delays, output transition time, pulse width, set-up, hold times, and maximum frequency

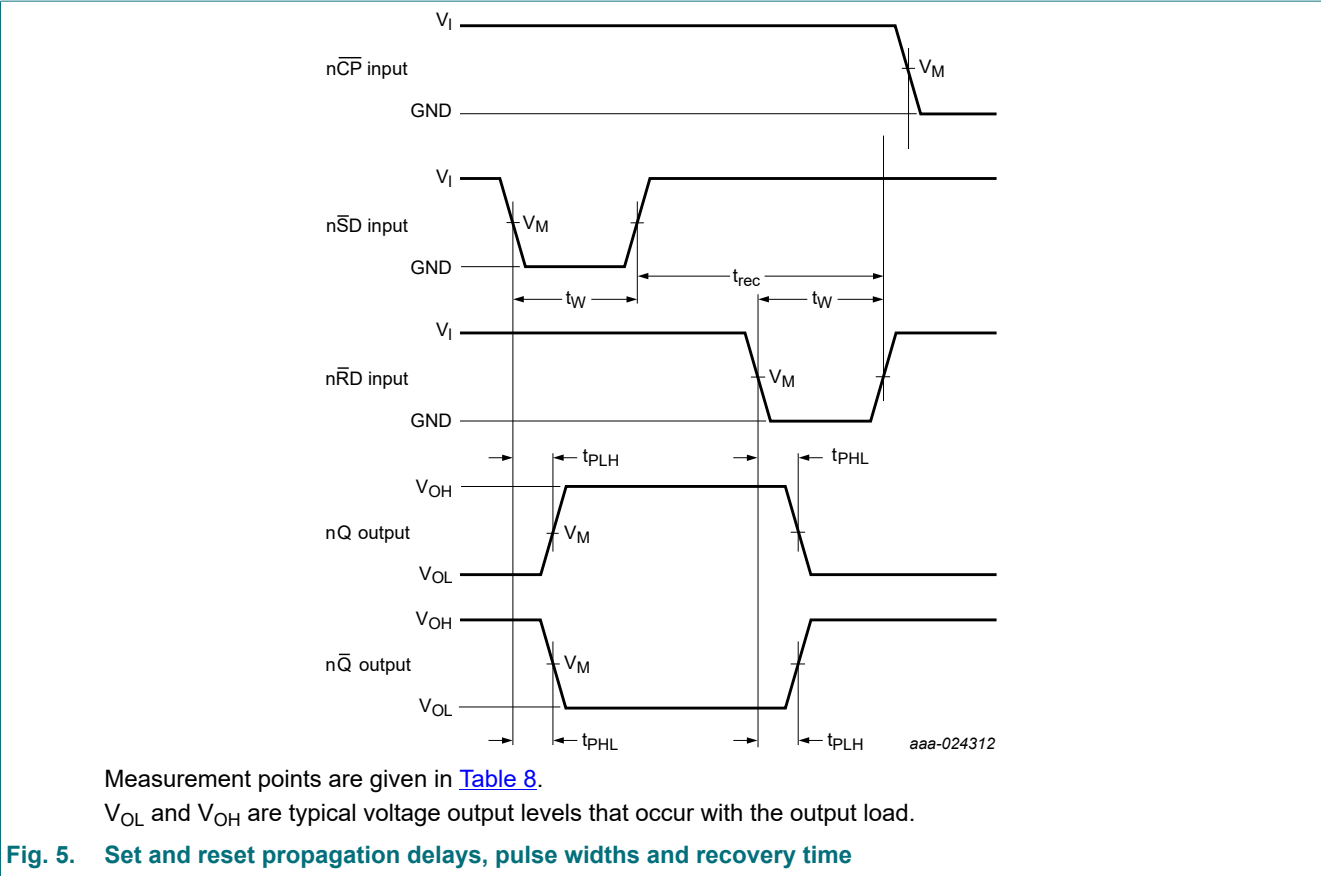


Table 8. Measurement points

Type	Input	Output
	V_M	V_M
74HC112	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$
74HCT112	1.3 V	1.3 V

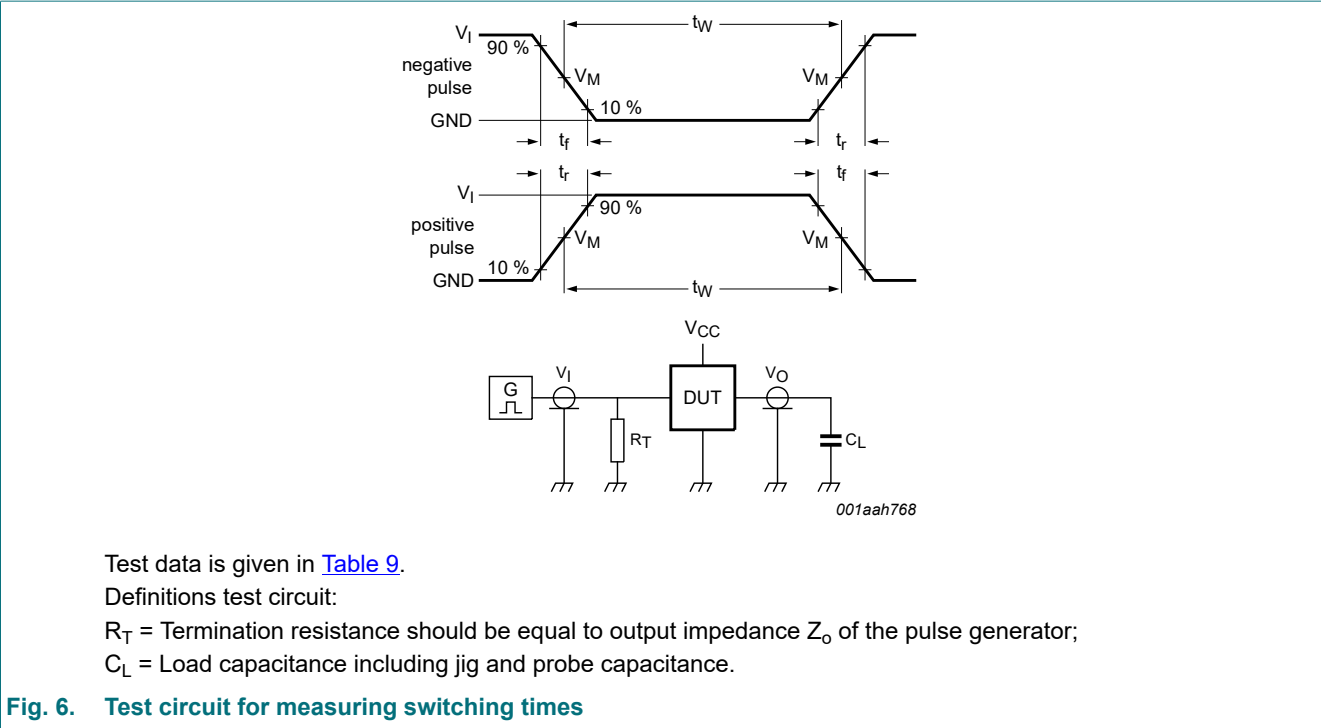


Table 9. Test data

Type	Input		Load	Test
	V_I	t_r, t_f	C_L	
74HC112	V_{CC}	6 ns	15 pF, 50 pF	t_{PLH}, t_{PHL}
74HCT112	3 V	6 ns	15 pF, 50 pF	t_{PLH}, t_{PHL}

11. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1

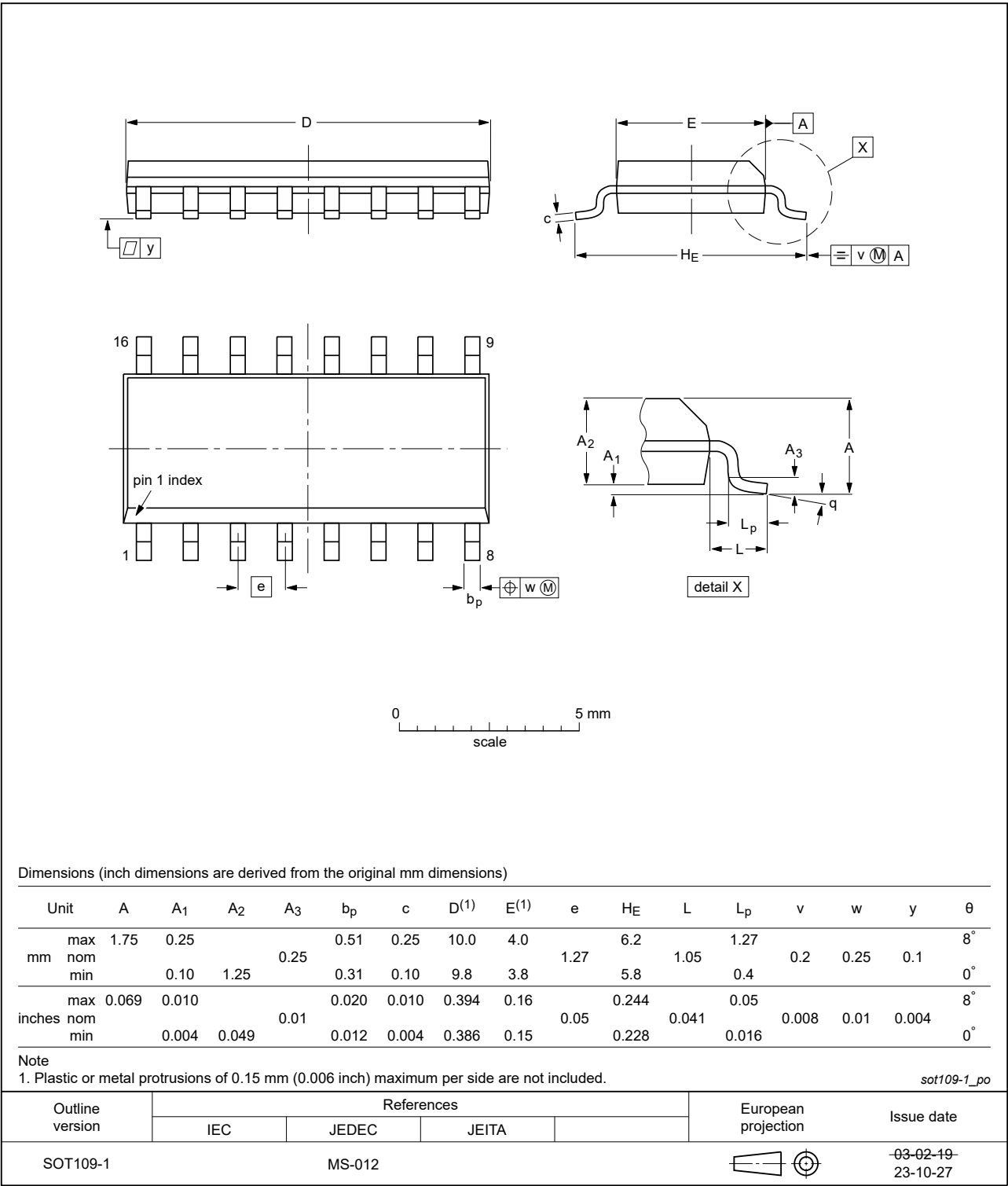


Fig. 7. Package outline SOT109-1 (SO16)

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1

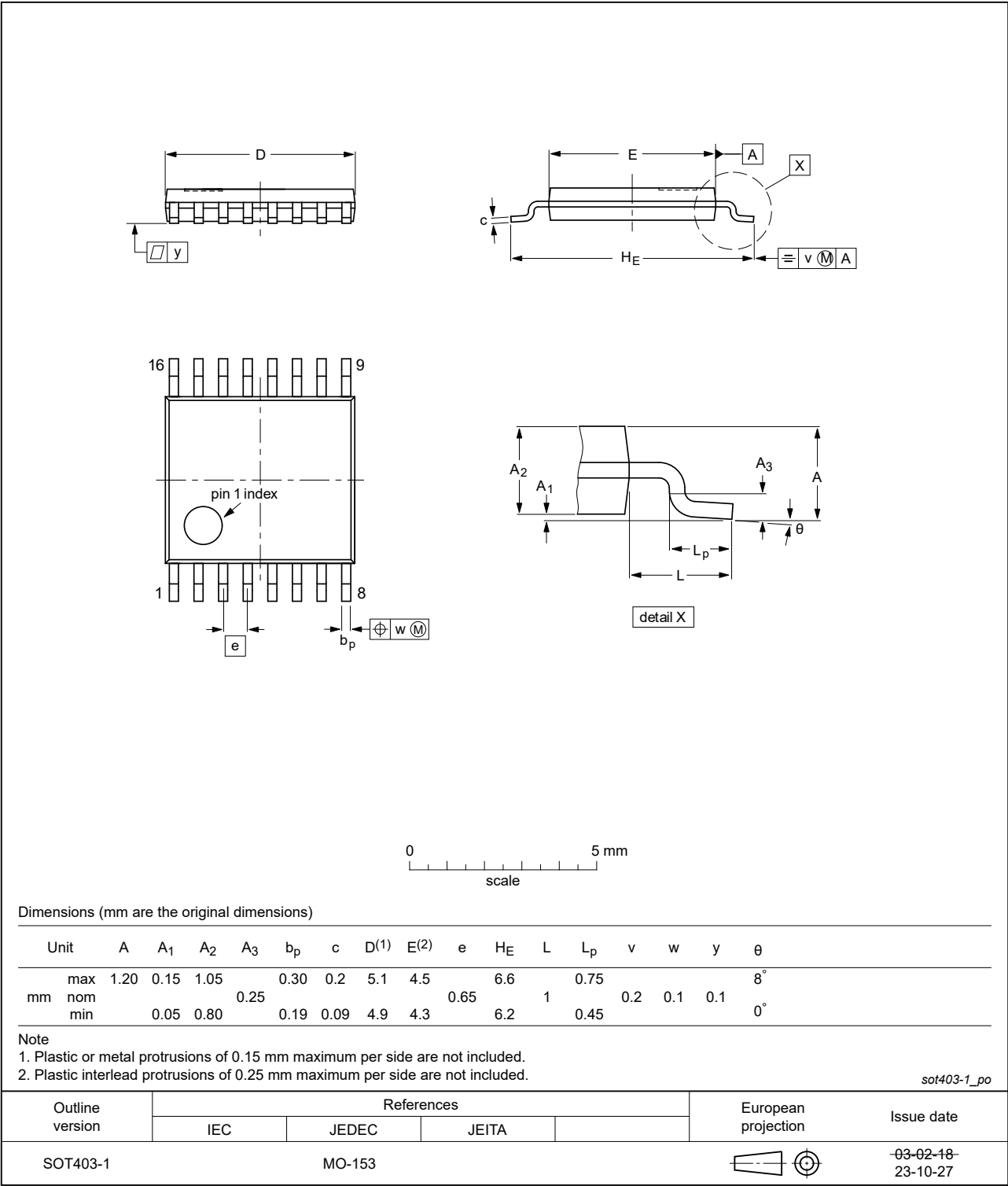


Fig. 8. Package outline SOT403-1 (TSSOP16)

12. Abbreviations

Table 10. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
TTL	Transistor-Transistor Logic

13. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT112 v.5	20240115	Product data sheet	-	74HC_HCT112 v.4
Modifications:	- Section 2: ESD specification updated according to the latest JEDEC standard. - Fig. 7, Fig. 8: Aligned SO and TSSOP package outline drawings to JEDEC MS-012 and MO-153			
74HC_HCT112 v.4	20210111	Product data sheet	-	74HC_HCT112 v.3
Modifications:	- The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. - Legal texts have been adapted to the new company name where appropriate. - Type numbers 74HC112DB and 74HCT112DB (SOT338-1 / SSOP16) removed. - Section 7: Derating values for P_{tot} total power dissipation have been updated.			
74HC_HCT112 v.3	20160809	Product data sheet	-	74HC_HCT112_CNV v.2
Modifications:	- The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. - Legal texts have been adapted to the new company name where appropriate. - Type numbers 74HC112N and 74HCT112N removed.			
74HC_HCT112_CNV v.2	19980610	Product specification	-	-

14. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <https://www.nexperia.com>.

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